

FEATURES

- Up to 3.2Gbps operation
- Modulation current to 60mA
- Rise/fall times 65ps typical
- Input 50Ω internally terminated to V_{CC}
- TTL /EN with internal 75kΩ pull-down
- Designed for use with MIC3000 optical transceiver management IC
- Voltage programmable laser modulation current
- Single 3.3V power supply
- Operating temperature range of -40°C to 85°C
- Available in tiny 16-pin MLF™ package

DESCRIPTION

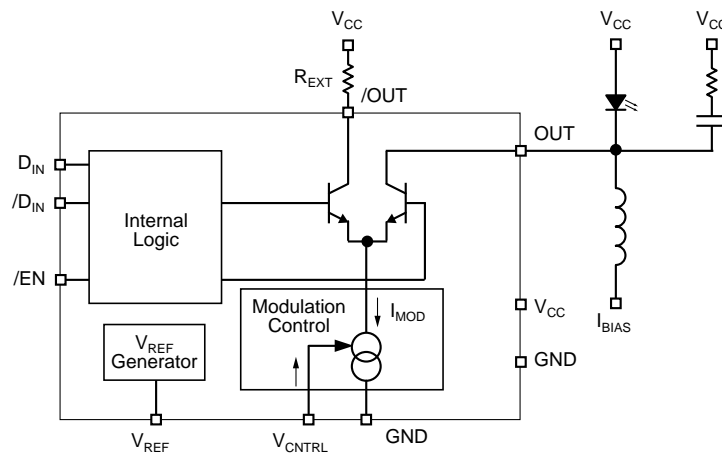
The SY88932L is the smallest available laser driver with a programmable modulation current up to 60mA for Fabry-Perot (FP) or distributed feedback (DFB) lasers. The device is suitable for SONET/SDH applications with data rates up to 3.2Gbps. The SY88932L accepts either CML level or AC-coupled PECL inputs, and incorporates an active low TTL /EN function which shuts off the modulation current when HIGH.

All support documentation can be found on Micrel's web site at www.micrel.com.

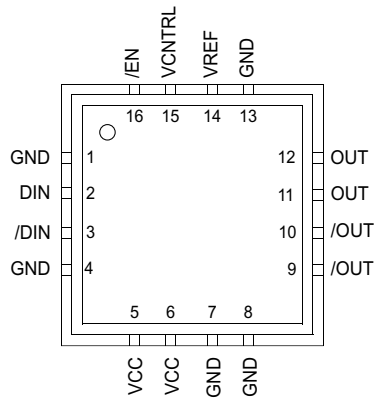
APPLICATIONS

- Fiber optical module
- Transponder
- XAUI CWDM
- SONET/SDH transmission system
- Add-drop MUX
- Metro area network
- 2.5Gbps optical transmitter

BLOCK DIAGRAM



PACKAGE/ORDERING INFORMATION



16-Pin MLF™

Ordering Information

Part Number	Package Type	Operating Range	Package Marking	Lead Finish
SY88932LMI	MLF-16	Industrial	932L	Sn-Pb
SY88932LMITR ⁽¹⁾	MLF-16	Industrial	932L	Sn-Pb
SY88932LMG	MLF-16	Industrial	932L with Pb-Free bar-line indicator	Pb-Free NiPdAu
SY88932LMGTR ⁽¹⁾	MLF-16	Industrial	932L with Pb-Free bar-line indicator	Pb-Free NiPdAu

Note:

1. Tape and Reel.

PIN DESCRIPTION

Pin Number	Pin Name	Pin Function
2, 3	DIN, /DIN	NRZ differential data (inputs), CML terminated interface with 50Ω to V _{CC} .
1, 4, 7, 8, 13	GND	Ground.
5, 6,	VCC	Positive power supply.
9, 10, 11, 12,	OUT, /OUT	Open collector (outputs) from the modulation driver.
14	VREF	Voltage reference, nominally 1.25V with respect to ground.
15	VCNTL	Voltage control of I _{MOD} . 5kΩ input impedance. See "Typical Operating Characteristics."
16	/EN	Enable: TTL compatible active low input with 75kΩ pull-down resistor.

TRUTH TABLE(1, 2)

D	/D	/EN	OUT ⁽³⁾	/OUT
L	H	L	H	L
H	L	L	L	H
X	X	H	H	L

Notes:

1. Truth table parameters are given for voltage rather than optical outputs. Hence, a voltage HIGH on OUT means no modulation current is flowing through OUT, and a voltage LOW on OUT means modulation current is flowing through OUT. A Voltage LOW implies an optical HIGH, and vice versa.
2. L = LOW, H = HIGH, X = don't care.
3. I_{OUT} ≤ I_{MOD_OFF} when /EN is HIGH.

Absolute Maximum Ratings⁽¹⁾

Supply Voltage (V_{CC})	-0.5V to +4.0V
CML Input Voltage (V_{IN})	$V_{CC} - 1.0V$ to $V_{CC} + 0.5V$
TTL Control Input Voltage (V_{IN})	0V to V_{CC}
Lead Temperature (soldering, 10 sec.)	265°C
Storage Temperature (T_S)	-65°C to +150°C

Operating Ratings⁽²⁾

Supply Voltage (V_{CC})	+3.0V to +3.6V
Ambient Temperature (T_A)	-40°C to +85°C
Junction Temperature (T_J)	-40°C to +120°C
Package Thermal Resistance ⁽³⁾	
MLF™ (θ_{JA}) Still-air	61°C/W
MLF™ (ψ_{JB}) Still-air	38°C/W

DC ELECTRICAL CHARACTERISTICS

$V_{CC} = 3.0$ to $3.6V$, $GND = 0V$, $T_A = -40^\circ C$ to $+85^\circ C$; Typical values at $V_{CC} = 3.3V$, $T_A = 25^\circ C$.

Symbol	Parameter	Condition	Min	Typ	Max	Units
I_{CC}	Power Supply Current	Note 4		57	80	mA
I_{MOD}	Modulation Current Range		10		60	mA
I_{MOD_OFF}	Modulation Off Current	/EN = V_{IHEN}			200	μA
V_{IR}	CML Input Voltage Range		$V_{CC} - 0.8$		$V_{CC} + 0.4$	V
V_{ID}	CML Input Differential Voltage (D_{IN} , / D_{IN})	Note 5	400	800	1600	mVpp
V_{IHEN}	TTL Input HIGH Voltage (/EN)		2.0			V
V_{ILEN}	TTL Input LOW Voltage (/EN)				0.8	V
V_{OUT}	Voltage (OUT, /OUT)	Note 6	$V_{CC} - 1.5$		V_{CC}	V
V_{REF}	Reference Voltage	Note 7	1.2	1.25	1.3	V

Notes:

- Permanent device damage may occur if Absolute Maximum Ratings are exceeded. This is a stress rating only and functional operation is not implied at conditions other than those detailed in the operational sections of this data sheet. Exposure to Absolute Maximum Ratings conditions for extended periods may affect device reliability.
- The data sheet limits are not guaranteed if the device is operated beyond the operating ratings.
- Thermal resistance numbers are for 4-layer PCB. Thermal performance assumes exposed pad is soldered (or equivalent) to the same potential as the ground pins on the PCB.
- Excluding I_{MOD} . I_{MOD} set to 60mA with 25 Ω load to V_{CC} on OUT, /OUT. Inputs floating.
- V_{ID} is the voltage required to guarantee a stable logic level. For logic "1", D_{IN} must be $\frac{V_{ID}}{2}$ above / D_{IN} . For stable logic "0", D_{IN} must be $\frac{V_{ID}}{2}$ below / D_{IN} .
- OUT and /OUT are current outputs. This specification defines the voltage range that the user must guarantee these pins remain within for proper operation.
- V_{REF} intended to source/sink $\leq |5mA|$.

AC ELECTRICAL CHARACTERISTICS⁽⁸⁾

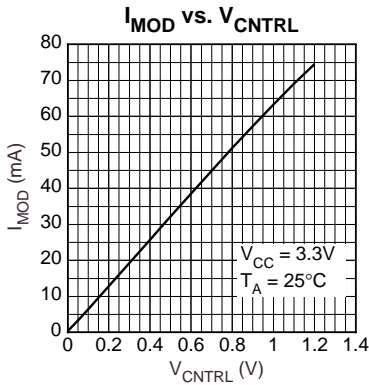
$V_{CC} = 3.0$ to $3.6V$, $GND = 0V$, $T_A = -40^{\circ}C$ to $+85^{\circ}C$; Typical values at $V_{CC} = 3.3V$, $T_A = 25^{\circ}C$, $R_{LOAD} = 25\Omega$ to V_{CC} (OUT, /OUT).

Symbol	Parameter	Condition	Min	Typ	Max	Units
t_r, t_f	Output Rise/Fall Times (20% to 80%)	Note 9		65	100	ps
DJ	Deterministic Jitter	Notes 9, 10		20		ps _{pp}

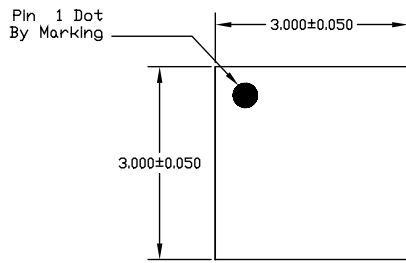
Notes:

- 8. AC characteristics are guaranteed by design and characterization.
- 9. $I_{MOD} = 60mA$.
- 10. Deterministic jitter measured using K28.5 pattern of 2.486Gbps, $V_{ID} = 1600mV_{pp}$.

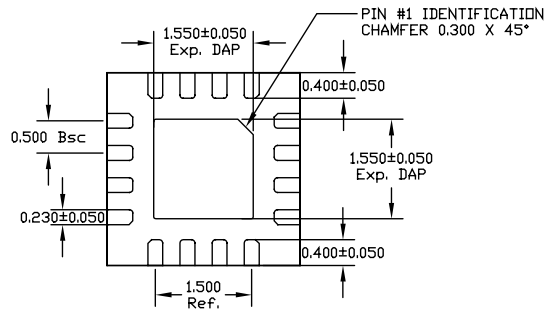
TYPICAL OPERATING CHARACTERISTICS



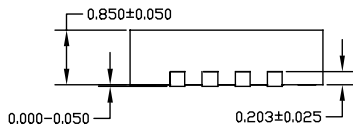
16 LEAD EPAD-MicroLeadFrame™ (MLF-16)



TOP VIEW

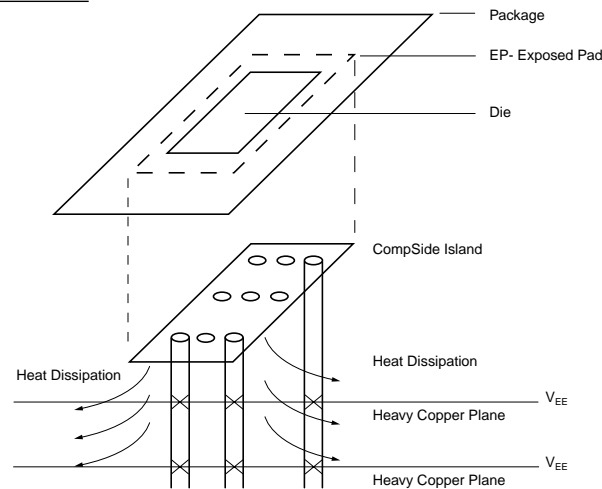


BOTTOM VIEW



SIDE VIEW

- NOTE:
1. ALL DIMENSIONS ARE IN MILLIMETERS.
 2. MAX. PACKAGE WARPAGE IS 0.05 mm.
 3. MAXIMUM ALLOWABLE BURRS IS 0.076 mm IN ALL DIRECTIONS.
 4. PIN #1 ID ON TOP WILL BE LASER/INK MARKED.



PCB Thermal Consideration for 16-Pin MLF™ Package

Package Notes:

1. Package meets Level 2 qualification.
2. All parts are dry-packaged before shipment.
3. Exposed pads must be soldered to a ground for proper thermal management.

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